502616622 12/30/2013

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2

EPAS ID: PAT2663215

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date	
SOONKI HONG	12/18/2013	

RECEIVING PARTY DATA

Name:	HYUNDAI MOTOR COMPANY		
Street Address:	12, HEOLLEUNG-RO, SEOCHO-GU		
City:	SEOUL		
State/Country:	KOREA, REPUBLIC OF		

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14144311

CORRESPONDENCE DATA

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Correspondence will be sent via US Mail when the email attempt is unsuccessful.

Correspondent Name: MORGAN, LEWIS & BOCKIUS LLP (SF)

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ATTORNEY DOCKET NUMBER:	060944-6070US
NAME OF SUBMITTER:	MONICA CARLOS
Signature:	/Monica Carlos/
Date:	12/30/2013

Total Attachments: 2

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have been received in full from said Assignee:

ASSIGNMENT (Joint Inventors)

WHEREAS, the undersigned, (1) <u>HONG, SOONKI</u>, resident of 311-1103, Hwabong Humansia Apt., Hwabong-dong, Buk-gu, Ulsan, Korea,

(hereinafter termed "Inventor"), respectively, have invented certain new and useful improvements in **PART**MACHINING APPARATUS FOR VEHICLE and executed therefore an application for Letters Patent of the United States and

1		having an c	ath or declaratio	on executed or	n even date	e herewith.			
(bearing U.S	. Patent Applica	ation No	a	nd filed on			
,	WHERE	EAS, HYUN	DAI MOTOI	R COMPAN	VY, a corp	oration of the	State of Rep	oublic of Kor	ea, having
			olleung-ro, Sec						
are desire	ous of ac	quiring the e	ntire right, title a	and interest in	nand to said	d application	and the inve	ntion disclos	ed therein
and in an	d to all	embodiment	s of the inventio	n, heretofore	conceived	, made or dis	covered join	tly or severa	lly by saic
			inafter termed ": (hereinafter tern						
•	NOW, T	THEREFOR	E, in considerati	on of good and	nd valuable	consideration	acknowled	ged by said I	nventor to

- 1. Said Inventor do hereby sell, assign, transfer and convey unto said Assignee, the entire right, title and interest (a) in and to said application and said invention; (b) in and to all rights to apply for foreign patents on said invention pursuant to the International Convention for the Protection of Industrial Property or otherwise; (c) in and to any and all applications filed and any and all patents granted on said invention in the United States or any foreign country, including each and every application filed and each and every patent granted on any application which is a division, substitution, or continuation of any of said applications; and (d) in and to each and every reissue or extensions of any of said patents.
- 2. Said Inventor do hereby jointly and severally covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right title and interest herein conveyed in the United States and foreign countries. Such cooperation by said Inventor shall include prompt production of pertinent facts and documents, giving of testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting substitute, divisional, continuing or additional applications covering said invention; (d) for filing and prosecuting applications for reissuance of any said patents; (e) for interference or other priority proceedings involving said invention; and (f) for legal proceedings involving said invention and any applications therefor and any patents granted thereon, including without limitation opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Inventor in providing such cooperation shall be paid for by said Assignee.
- 3. The terms and covenants of this assignment shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Inventor, their respective heirs, legal

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representatives and assigns.

4. Said Inventor do hereby jointly and severally warrant and represent that they have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, the said Inventor have executed and delivered this instrument to said Assignee as follows:

Date: 18/12/26/3 (1) HONG, SOONKI

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RECORDED: 12/30/2013

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